

C0603C153G8TACTU

Aliases (C0603C153G8TAC7867) SMD Comm X8G HT150C, Ceramic, 0.015 uF, 2%, 10 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	3.7 mg
Shelf Life	78 Weeks
MSL	1

0.015 uF

Time is 1000 Hours

66.6667 GOhms

Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.07mm
S	0.5mm MIN
В	0.35mm +/-0.15mm

	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	2%
	Voltage DC	10 VDC
	Dielectric Withstanding Voltage	25 VDC
	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
pe	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour: Referee

Specifications

Insulation Resistance

Capacitance

Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

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